



## NTE5329 thru NTE5331 Single Phase Bridge Rectifier 6 Amp

### **Features:**

- High Case Dielectric Strength of 1500V<sub>RMS</sub>
- Surge Overload Rating: 175A (Peak)
- Ideal for Printed Circuit Board
- Reliable Construction Utilizing Molded Plastic Technique

**Maximum Ratings and Electrical Characteristics:** ( $T_A = +25^\circ\text{C}$  unless otherwise specified.  
60Hz Resistive or Inductive Load. For Capacitive Load, Derate Current by 20%)

Maximum Recurrent Peak Reverse Voltage,  $P_{RV}$

NTE5329 .....	200V
NTE5330 .....	600V
NTE5331 .....	1000V

Maximum RMS Voltage,  $V_{RMS}$

NTE5329 .....	140V
NTE5330 .....	420V
NTE5331 .....	700V

Maximum DC Blocking Voltage,  $V_{DC}$

NTE5329 .....	200V
NTE5330 .....	600V
NTE5331 .....	1000V

Maximum Average Forward Output Current,  $I_{F(AV)}$

$T_C = +100^\circ\text{C}$ .....	6A
$T_A = +40^\circ\text{C}$ .....	6A

Peak Forward Surge Current,  $I_{FSM}$

(Half Sine-Wave Superimposed on Rated Load) .....	175A
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Maximum Instantaneous Forward Voltage Drop (Per Bridge Element,  $I_F = 6\text{A}$ ),  $V_F$  .....

1.0V

Maximum DC Reverse Current (at Rated DC Blocking Voltage per Element),  $I_R$

$T_A = +25^\circ\text{C}$ .....	5μA
$T_A = +125^\circ\text{C}$ .....	1mA

Operating Junction Temperature Range,  $T_J$  .....

-50° to +150°C

Storage Temperature Range,  $T_{stg}$  .....

-50° to +150°C

Thermal Resistance, Junction-to-Case (Note 1),  $R_{thJC}$  .....

4.7°C/W

Thermal Resistance, Junction-to-Ambient (Note 2),  $R_{thJA}$  .....

4.7°C/W

Note 1. Mounted on a 2.6" x 1.4" x 0.06" THK (6.5cm. x 3.5cm. x 1.5cm.) Al. Plate

Note 2. P.C. Board mounted on 0.5" sq. (12mm<sup>2</sup>) Cu. pads, .375" (9.5mm) lead lengths

Note 3. Recommended mounting position is to bolt down on heatsink with silicone thermal compound for maximum heat transfer with #6 screw.

